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## **BIB DATA SHEET**

SERIAL NUMBER   TILING or 371(c)   DATE		CONFIRMATION NO. 923										
APPLICANTS	SERIAL NUMI	BER	FILING	r_ 371(c)		CLASS	GR	GROUP ART UNIT		ATTORNEY DOCKET		
APPLICANTS Ludwig Dittmar, Dresden, GERMANY; Wolfgang Gustin, Dorfen, GERMANY; Maik Stegemann, Dresden, GERMANY; Maik Stegemann, Dresden, GERMANY; **CONTINUING DATA** This application is a 371 of PCT/DE03/02104 06/24/2003 **FOREIGN APPLICATIONS** GERMANY 102 29 188.8 06/28/2002  **IF REQUIRED, FOREIGN FILING LICENSE GRANTED**  Foreign Priority islamed	10/519,74					254		2812				
Ludwig Ditmar, Dresden, GERMANY; Wolfgang Gustin, Dorfen, GERMANY; Malk Stegemann, Dresden, GERMANY; This application is a 371 of PCT/DE03/02104 06/24/2003  **FOREIGN APPLICATIONS*** GERMANY 102 29 18.8 06/28/2002  **IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** Foreign Priority dalmed			RUL	E								
This application is a 371 of PCT/DE03/02104 06/24/2003  **FOREIGN APPLICATIONS**** GERMANY 10 22 91 88.8 06/26/2002  **IF REQUIRED, FOREIGN FILING LICENSE GRANTED **  Foreign Priority claimed	Ludwig Ditmar, Dresden, GERMANY; Wolfgang Gustin, Dorfen, GERMANY; Malk Stegemann, Dresden, GERMANY;											
GERMANY 10 2 29 188.8 06/28/2002 ** IF REQUIRED, FOREIGN FILING LICENSE GRANTED **  Prolip Priority Guided												
Foreign Priority claimed	GERMANY 102 29 188.8 06/28/2002											
SUSC 119(a-d) conditions met												
Verified and Acknowledged   THULHUNG T   TRIMBIN   GERMANY   6   1   1				Met at	fter							
ADDRESS  SLATER & MATSIL LLP 17950 PRESTON ROAD SUITE 1000 DALLAS, TX 75252 UNITED STATES  TITLE  Method for contacting parts of a component integrated into a semiconductor substrate  FILING FEE RECEIVED 1160  FEES: Authority has been given in Paper No for following:    Call Fees   Call	Verified and /1	THU-HUO	NG T		1109	GERMANY		6	1		1	
17950 PRESTON ROAD SUITE 1000 DALLAS, TX 75252 UNITED STATES  TITLE  Method for contacting parts of a component integrated into a semiconductor substrate  FILING FEE RECEIVED 1160  FEES: Authority has been given in Paper No to charge/credit DEPOSIT ACCOUNT No for following:    Call Fees   Call Fees     1.16 Fees (Filing)     1.17 Fees (Processing Ext. of time)     1.18 Fees (Issue)     Other												
Method for contacting parts of a component integrated into a semiconductor substrate    FILING FEE   RECEIVED   1160   11	17950 PRESTON ROAD SUITE 1000 DALLAS, TX 75252											
FILING FEE RECEIVED 1160  FEES: Authority has been given in Paper No to charge/credit DEPOSIT ACCOUNT No for following:    All Fees     1.16 Fees (Filing)     1.17 Fees (Processing Ext. of time)     1.18 Fees (Issue)     Other	TITLE											
FILING FEE RECEIVED 1160 FEES: Authority has been given in Paper No to charge/credit DEPOSIT ACCOUNT No for following:	Method for contacting parts of a component integrated into a semiconductor substrate											
FILING FEE RECEIVED 1160  FEES: Authority has been given in Paper No to charge/credit DEPOSIT ACCOUNT No for following:  □ 1.17 Fees (Processing Ext. of time) □ 1.18 Fees (Issue) □ Other								☐ All Fees				
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